

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4011	(multilayer (multi adj2 (layer layered layering cover sheet metal substrate))) same (reinforcing reinforced reinforced strengthening strengthen strength) same (chip die semiconductor dice component ic (integrated adj circuit))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 19:43
L2	2246	(aluminum copper cu nickel ni) and 1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 19:43
L3	426	frame and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 19:43